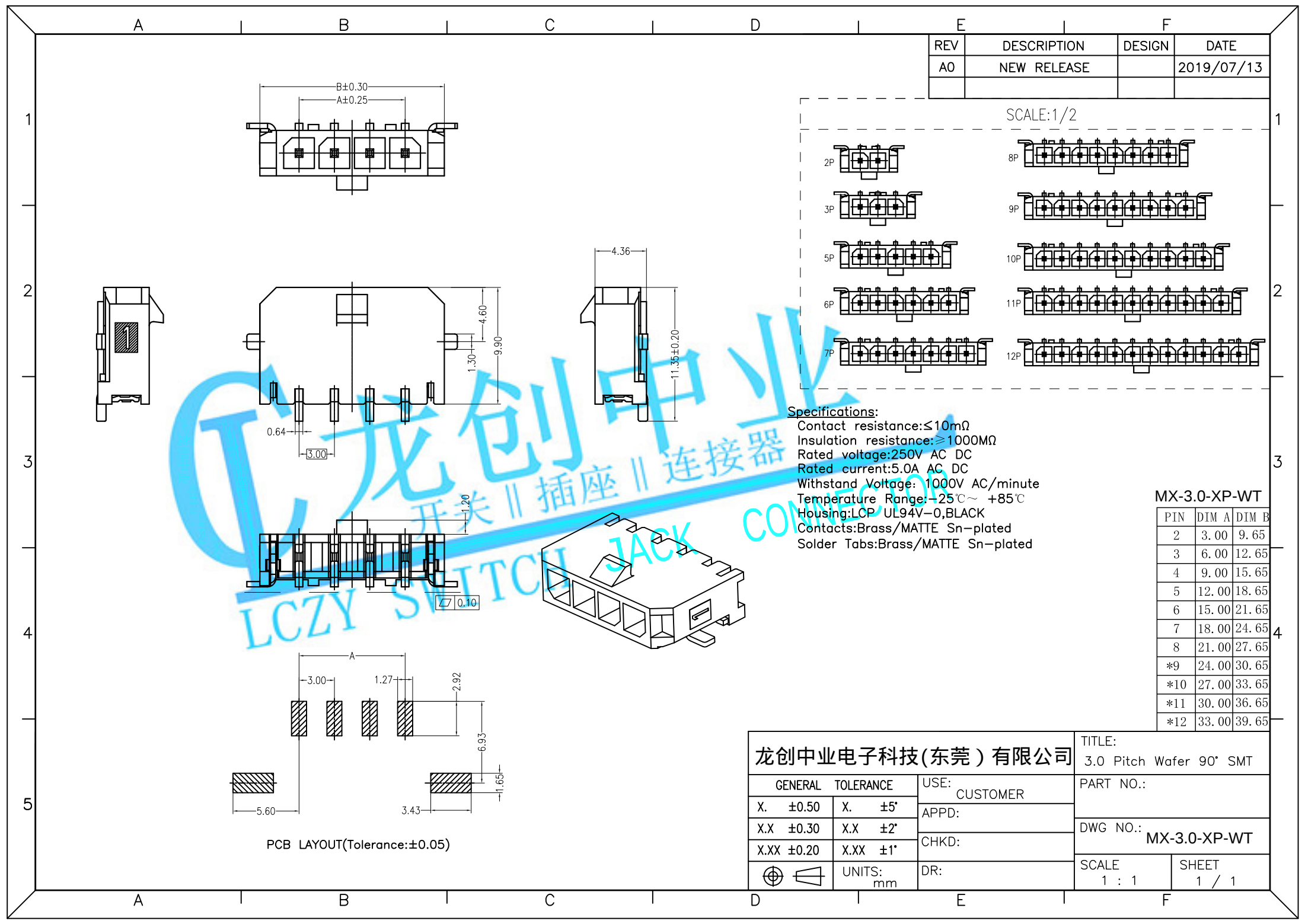
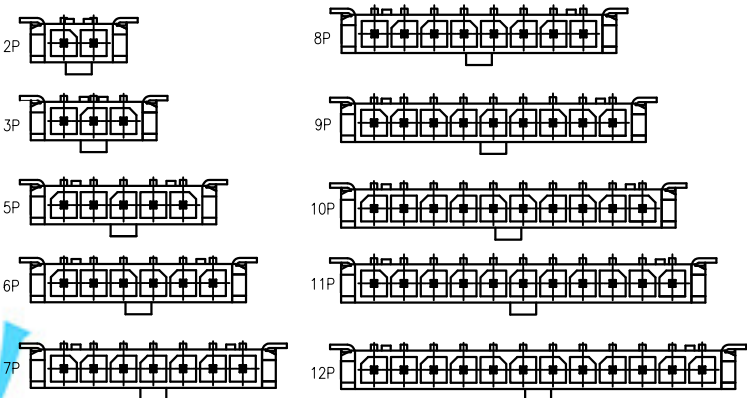




REV	DESCRIPTION	DESIGN	DATE
A0	NEW RELEASE		2019/07/13

SCALE:1/2



Specifications:
Contact resistance:≤10mΩ
Insulation resistance:≥1000MΩ
Rated voltage:250V AC DC
Rated current:5.0A AC DC
Withstand Voltage: 1000V AC/minute
Temperature Range:-25℃~ +85℃
Housing:LCP UL94V-0, BLACK
Contacts:Brass/MATTE Sn-plated
Solder Tabs:Brass/MATTE Sn-plated

MX-3.0-XP-WT

PIN	DIM A	DIM B
2	3.00	9.65
3	6.00	12.65
4	9.00	15.65
5	12.00	18.65
6	15.00	21.65
7	18.00	24.65
8	21.00	27.65
*9	24.00	30.65
*10	27.00	33.65
*11	30.00	36.65
*12	33.00	39.65

龙创中业电子科技(东莞)有限公司			TITLE: 3.0 Pitch Wafer 90° SMT	
GENERAL TOLERANCE		USE: CUSTOMER	PART NO.:	
X. ±0.50	X. ±5°		DWG NO.:	
X.X ±0.30	X.X ±2°		MX-3.0-XP-WT	
X.XX ±0.20	X.XX ±1°	CHKD:	SCALE	
UNITS: mm		DR:	1 : 1	SHEET 1 / 1